L Number	Hits	Search Text	DB	Time stamp
1	79941	rotat$5 with (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 09:57
2	189449	sputter$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 09:57
3	0	taregt with offset with (wafer or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 09:57
4	244	target with offset with (wafer or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 09:58
5	15	(rotat$5 with (substrate or wafer)) same sputter$3 same (target with offset with (wafer or substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:02
6	36	((rotat$5 with (substrate or wafer)) and sputter$3 and (target with offset with (wafer or substrate))) not ((rotat$5 with (substrate or wafer)) same sputter$3 same (target with offset with (wafer or substrate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:02
7	7615	load adj lock	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:11
8	67622	detect$3 near2 rotat$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:12
9	3770	(rotat$5 with (substrate or wafer)) same sputter$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:12
10	7	(load adj lock) and (detect$3 near2 rotat$3) and ((rotat$5 with (substrate or wafer)) same sputter$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:12
13	39	(rotat$5 with (substrate or wafer)) same (target with offset with (wafer or substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/09 10:20